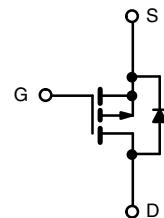


PRODUCT SUMMARY

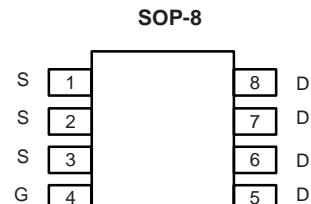
V _{DS} (V)	-30
R _{DS(on)} max. (mΩ) at V _{GS} = 10 V	5
R _{DS(on)} max. (mΩ) at V _{GS} = 4.5 V	8
Q _g typ. (nC)	27
I _D (A)	18
Configuration	Single



P-Channel MOSFET

APPLICATIONS

- Battery management in mobile devices
- Adapter and charger switch
- Battery switch
- Load switch



Top View

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	V _{DS}	-30	
Gate-source voltage	V _{GS}	± 20	V
Continuous drain current (T _J = 150 °C)	T _C = 25 °C	-18	A
	T _C = 70 °C	-13	
	T _A = 25 °C	-11	
	T _A = 70 °C	-8	
Pulsed drain current (t = 100 µs)	I _{DM}	-145	
Continuous source-drain diode current	T _C = 25 °C	-5	
	T _A = 25 °C	-2.8 b, c	
Single pulse avalanche current	I _{AS}	-25	
Single pulse avalanche energy	E _{AS}	31.2	mJ
Maximum power dissipation	T _C = 25 °C	5.6	W
	T _C = 70 °C	3.6	
	T _A = 25 °C	3.1 b, c	
	T _A = 70 °C	2 b, c	
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	
Soldering recommendations (peak temperature) ^c		260	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	34	40
Maximum junction-to-case (drain)	Steady state	R _{thJF}	18	22

Notes

- Package limited
- Surface mounted on 1" x 1" FR4 board
- t = 10 s
- The SOP-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 85 °C/W
- T_C = 25 °C

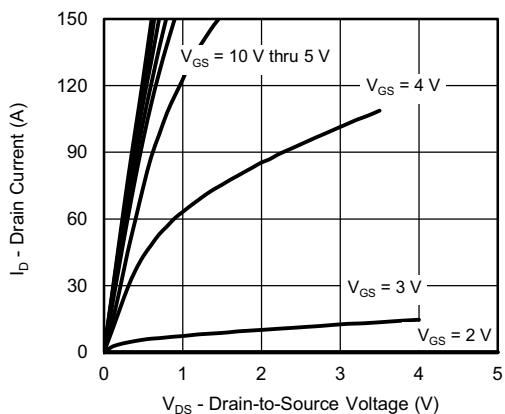
SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	$I_D = -10 \text{ mA}$	-	-17	-	mV/°C
$V_{GS(\text{th})}$ temperature coefficient	$\Delta V_{GS(\text{th})}/T_J$	$I_D = -250 \mu\text{A}$	-	5.5	-	
Gate-source threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	-1	-	-2.2	V
Gate-source leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +16 / -20 \text{ V}$	-	-	100	nA
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μA
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$	-	-	-15	
On-state drain current ^a	$I_{D(\text{on})}$	$V_{DS} \geq -10 \text{ V}, V_{GS} = -10 \text{ V}$	-40	-	-	A
Drain-source on-state resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}, I_D = -15 \text{ A}$	-	5	-	mΩ
		$V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	8	-	
Forward transconductance ^a	g_{fs}	$V_{DS} = -15 \text{ V}, I_D = -15 \text{ A}$	-	81	-	S
Dynamic ^b						
Input capacitance	C_{iss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	3490	-	pF
Output capacitance	C_{oss}		-	1420	-	
Reverse transfer capacitance	C_{rss}		-	70	-	
Total gate charge	Q_g	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	56	84	nC
Gate-source charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$	-	27	41	
Gate-drain charge	Q_{gd}		-	9.4	-	
Gate resistance	R_g		$f = 1 \text{ MHz}$	1.5	3.5	6
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -15 \text{ V}, R_L = 1.5 \Omega, I_D \leq -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	15	30	ns
Rise time	t_r		-	6	12	
Turn-off delay time	$t_{d(off)}$		-	39	78	
Fall time	t_f		-	10	20	
Turn-on delay time	$t_{d(on)}$		-	34	68	
Rise time	t_r	$V_{DD} = -15 \text{ V}, R_L = 1.5 \Omega, I_D \leq -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	86	172	ns
Turn-off delay time	$t_{d(off)}$		-	31	62	
Fall time	t_f		-	22	44	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	$T_C = 25^\circ\text{C}$	-	-	-5	A
Pulse diode forward current	I_{SM}		-	-	-150	
Body diode voltage	V_{SD}	$I_S = -5 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.73	-1.1	V
Body diode reverse recovery time	t_{rr}	$I_F = -10 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$	-	44	88	ns
Body diode reverse recovery charge	Q_{rr}		-	41	82	
Reverse recovery fall time	t_a		-	19	-	nC
Reverse recovery rise time	t_b		-	25	-	

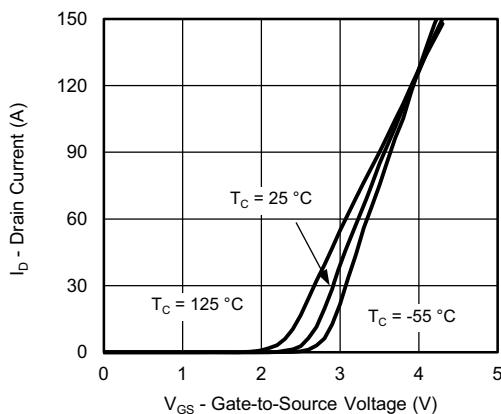
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$
 b. Guaranteed by design, not subject to production testing

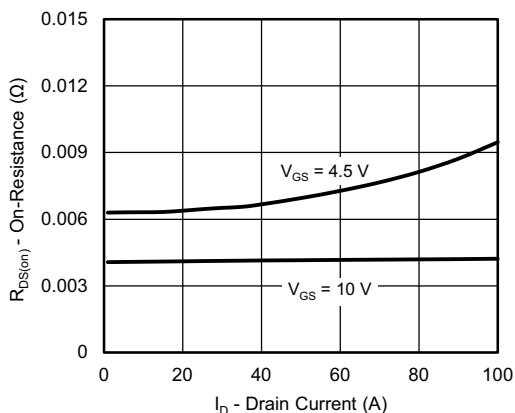
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



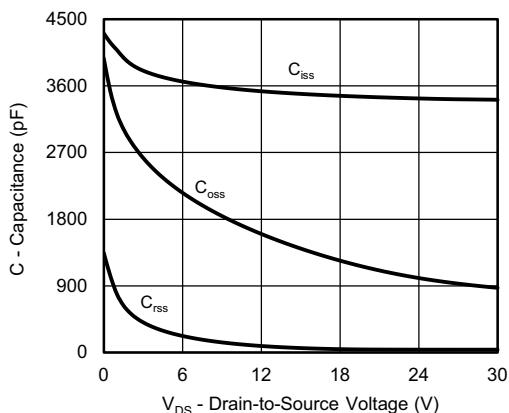
Output Characteristics



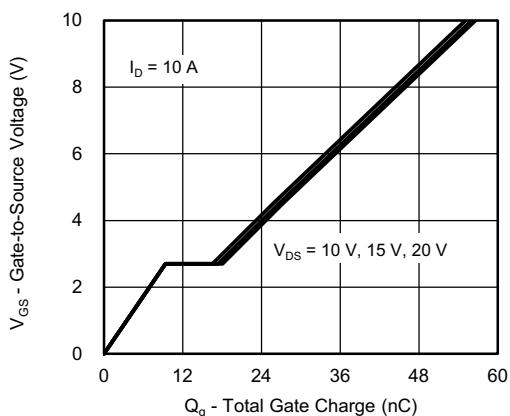
Transfer Characteristics



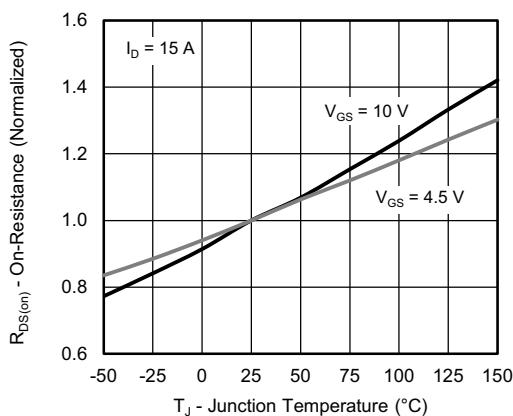
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

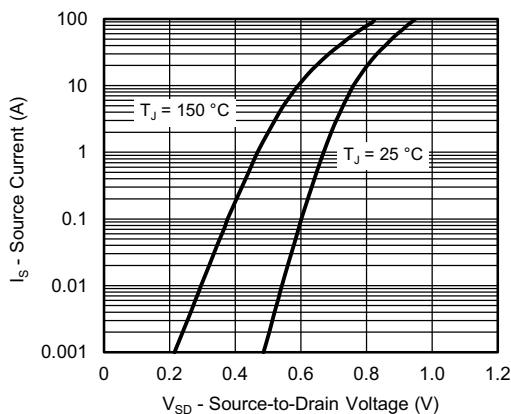


Gate Charge

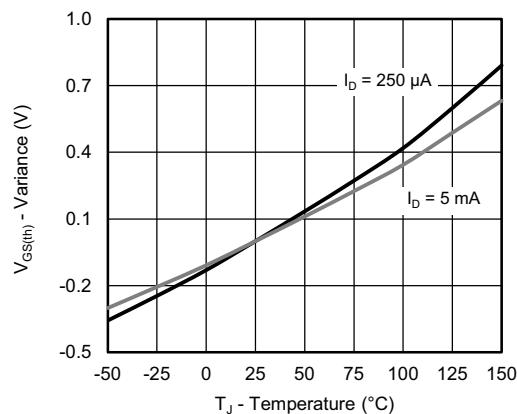


On-Resistance vs. Junction Temperature

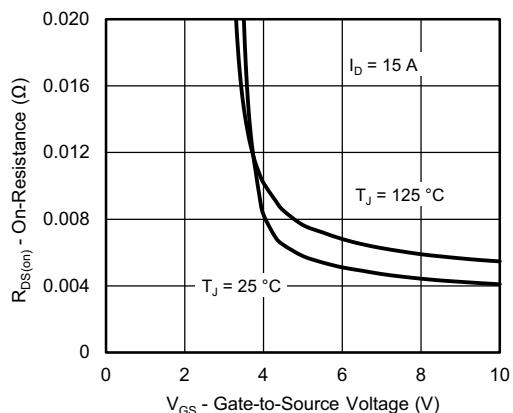
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



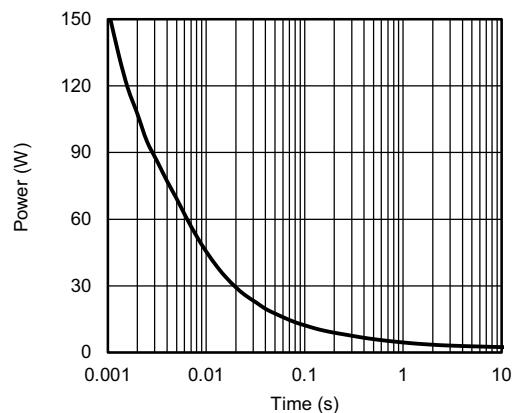
Source-Drain Diode Forward Voltage



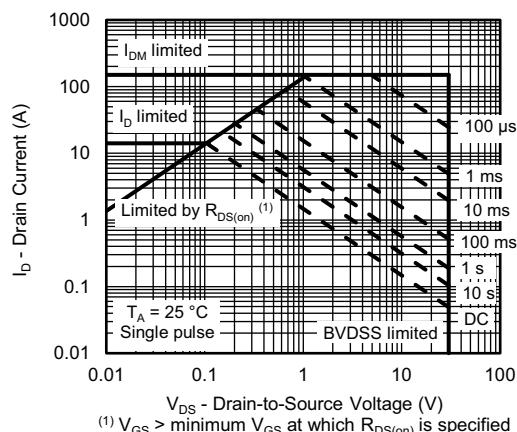
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

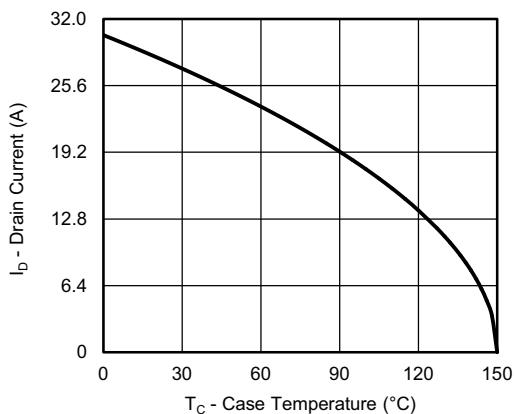


Single Pulse Power, Junction-to-Ambient

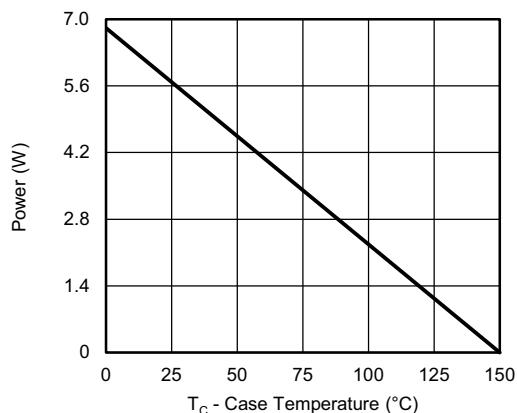


Safe Operating Area, Junction-to-Ambient

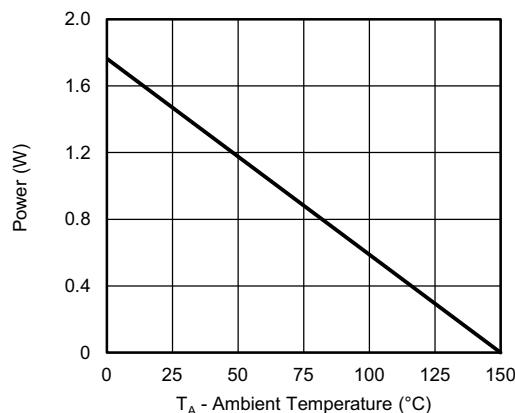
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case

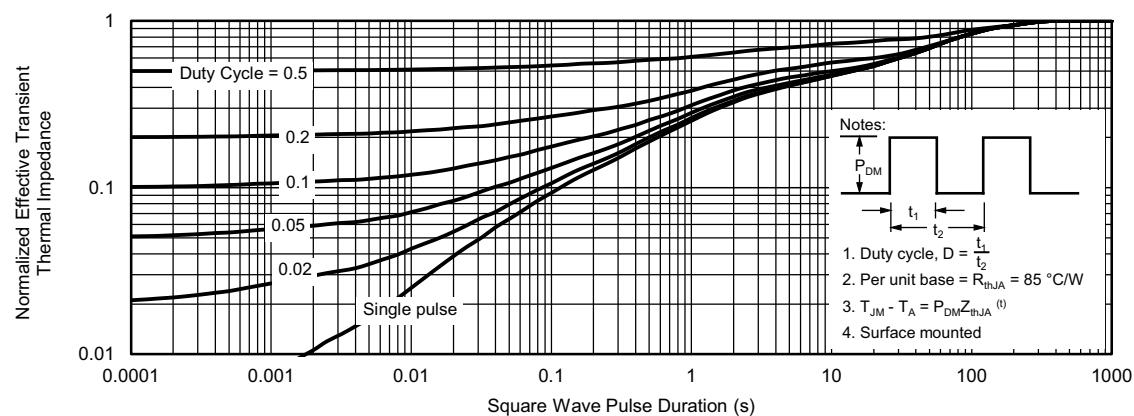


Power, Junction-to-Ambient

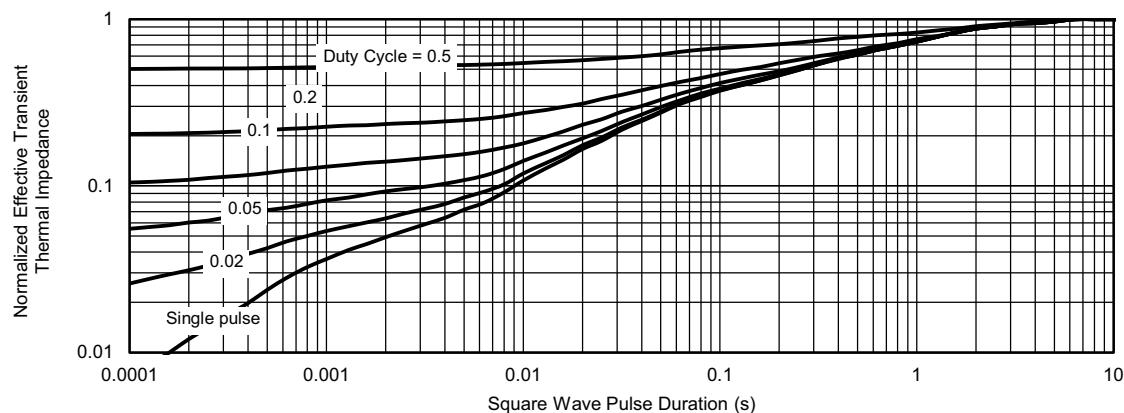
Note

- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

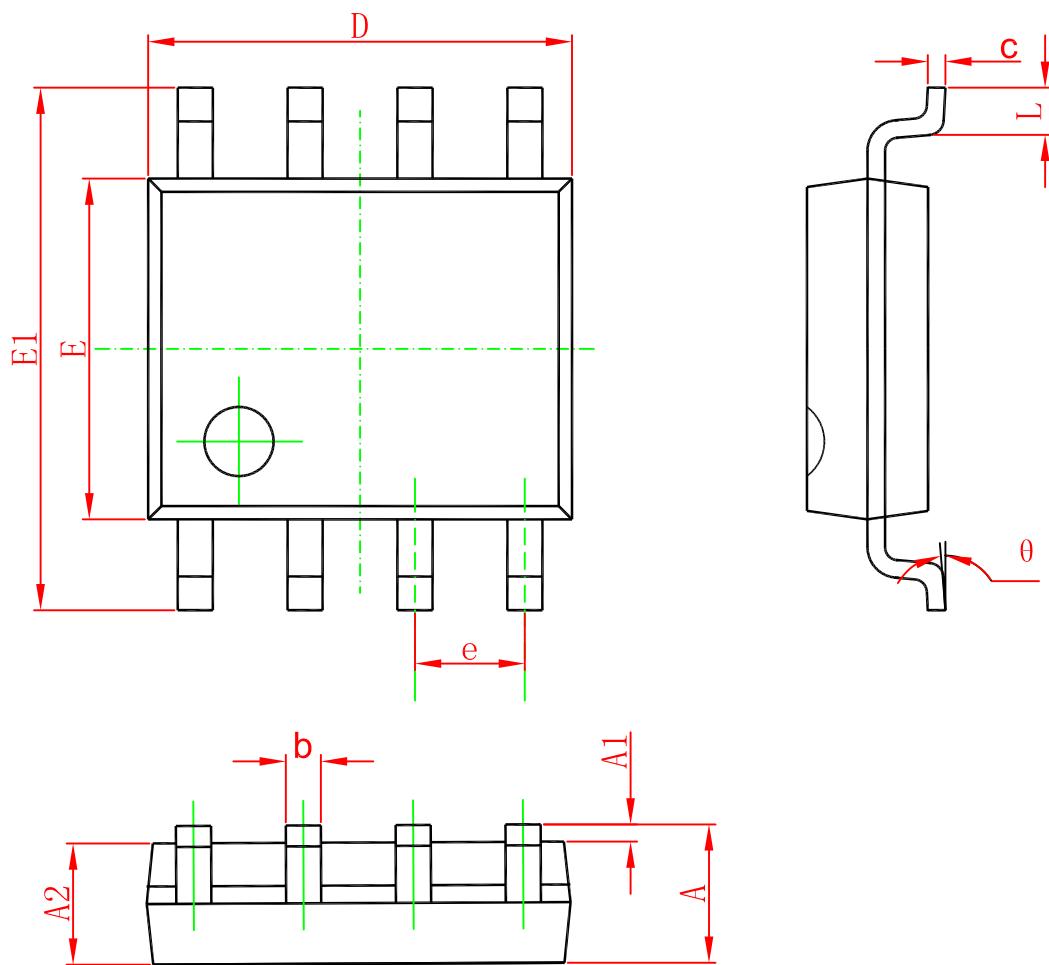


Normalized Thermal Transient Impedance, Junction-to-Ambient



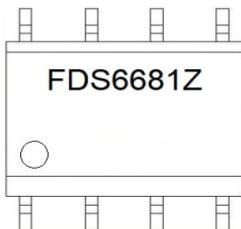
Normalized Thermal Transient Impedance, Junction-to-Case

SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
FDS6681Z	SOP-8	3000	Tape and reel